

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JEHUDA SHEMER	10/16/2017
ASSAF NATANZON	10/03/2017
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15724010
CORRESPONDENCE DATA	
Fax Number:	(408)720-8383
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(714)557-3800
Email:	maria_macedo@bstz.com
Correspondent Name:	BLAKELY SOKOLOFF TAYLOR & ZAFMAN LLP
Address Line 1:	1279 OAKMEAD PARKWAY
Address Line 4:	SUNNYVALE, CALIFORNIA 94085-4040
ATTORNEY DOCKET NUMBER:	6368P252
NAME OF SUBMITTER:	TRI C. DANG, REG. NO. 71,853
SIGNATURE:	/Tri C. Dang/
DATE SIGNED:	10/17/2017
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, we, Jehuda Shemer and Assaf Natanzon have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled METHODS AND SYSTEMS FOR SOFTWARE PROTECTION WITHIN AN ISOLATED ENVIRONMENT (Application), the specification of which:

is being executed on even date herewith and is about to be filed in the United States Patent Office;

was filed on 10/03/2017 as U.S. Application No. 15/724,010 ;

was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the

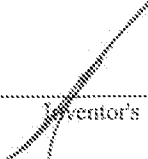
giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND, we hereby authorize our attorneys, EMC IP Holding Company LLC, to insert here in parentheses (15/724,010) the application number and filing date of said Application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 11/10/2017


Inventor's Signature

Print full name of first inventor:

Jehuda Shemer

Residence:

Brener 7/7
Kfar Saba, Israel 4434907

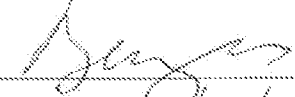
Citizenship:

Israel

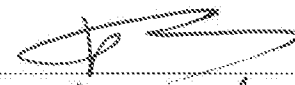
Mailing Address:

Same as above

I, Roman Zindel (name) whose residential address is
Te Sheevy 4/22 Metanya was personally
present and did see Jehuda Shemer (name of person signing the assignment) who is personally
known to me, execute the above assignment.

 (signature of first witness)
Signed at Heetzelia (location of witness signature)
on this day Oct 16 of 20 17 (date of signature)

I, Leonid Bershatzky (name) whose residential address is
Beit Na-Azava 3/18, Rishon Le-Zion, Israel was personally
present and did see Jehuda Shemer (name of person signing the assignment) who is personally
known to me, execute the above assignment.

 (signature of first witness)
Signed at Heetzelia (location of witness signature)
on this day 10/16 of 20 17 (date of signature)

Date: 3/16/17

[Signature]
Inventor's Signature

Print full name of first inventor: Assaf Natanzon
Residence: Levanon 95
Tel Aviv, Israel 6997702
Citizenship: Israel
Mailing Address: Same as above

I Lionel Mor Yosaf (name) whose residential address is
Guantanamo, Ben Gurion 190 St. Israel was personally
present and did see Assaf Natanzon (name of person signing the assignment) who is personally known
to me, execute the above assignment.

[Signature] (signature of first witness)
Signed at Dell EMC Herzliya (location of witness signature)
on this day 3/16 of 20 17 (date of signature)

I Shenkar Javan (name) whose residential address is
Hay Togeib 25 Habra was personally
present and did see Assaf Natanzon (name of person signing the assignment) who is personally known
to me, execute the above assignment.

[Signature] (signature of first witness)
Signed at Dell EMC Herzliya (location of witness signature)
on this day 3/16 of 20 17 (date of signature)